



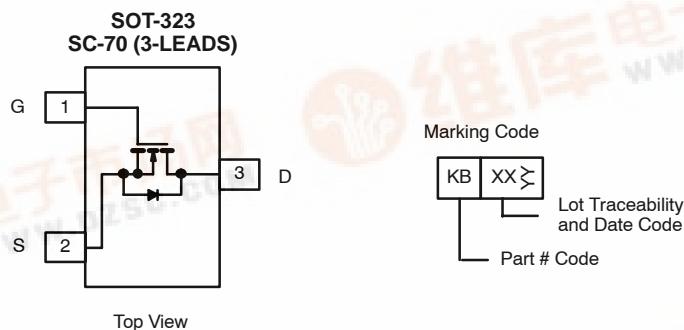
Si1304DL

Vishay Siliconix

## N-Channel 25-V (D-S) MOSFET

**TrenchFET®**  
Power MOSFETs

PRODUCT SUMMARY			
V <sub>DS</sub> (V)	r <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)	Q <sub>g</sub> (Typ)
25	0.350 @ V <sub>GS</sub> = 4.5 V	0.75	1.3
	0.450 @ V <sub>GS</sub> = 2.5 V	0.66	



Ordering Information: Si1304DL-T1

ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C UNLESS OTHERWISE NOTED)

Parameter	Symbol	5 secs	Steady State	Unit	
Drain-Source Voltage	V <sub>DS</sub>	25		V	
Gate-Source Voltage	V <sub>GS</sub>				
Continuous Drain Current (T <sub>J</sub> = 150°C) <sup>a</sup>	T <sub>A</sub> = 25°C	0.75	0.70	A	
	T <sub>A</sub> = 70°C				
Pulsed Drain Current	I <sub>DM</sub>	3.0			
Continuous Diode Current (Diode Conduction) <sup>a</sup>	I <sub>S</sub>	0.28	0.24		
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25°C	0.33	0.29	W	
	T <sub>A</sub> = 70°C				
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 150		°C	

## THERMAL RESISTANCE RATINGS

Parameter	Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a</sup>	t ≤ 5 sec	R <sub>thJA</sub>	315	375
	Steady State		380	450
Maximum Junction-to-Foot (Drain)	R <sub>thJF</sub>	285	340	°C/W

Notes

a. Surface Mounted on 1" x 1" FR4 Board.



**SPECIFICATIONS ( $T_J = 25^\circ\text{C}$  UNLESS OTHERWISE NOTED)**

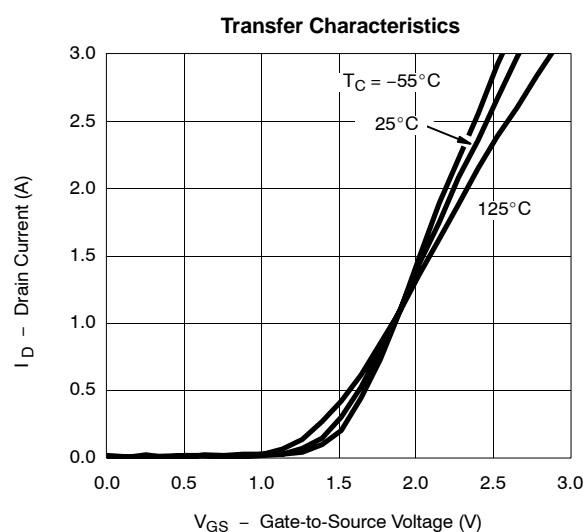
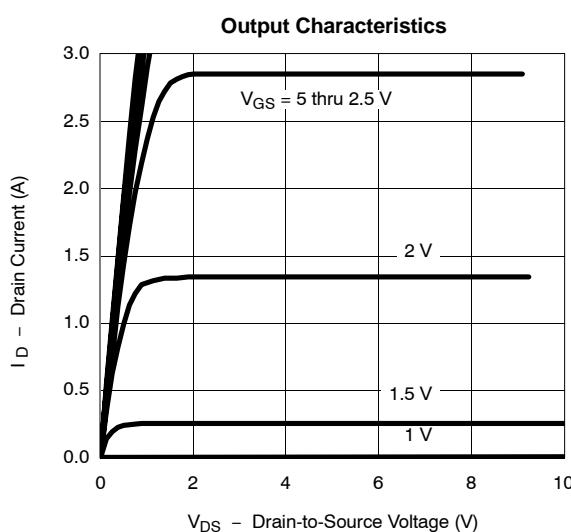
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static</b>						
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	0.6		1.3	V
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}$		1		$\mu\text{A}$
		$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 70^\circ\text{C}$		5		
On-State Drain Current <sup>a</sup>	$I_{D(\text{on})}$	$V_{DS} = 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	3.0			A
Drain-Source On-State Resistance <sup>a</sup>	$r_{DS(\text{on})}$	$V_{GS} = 4.5 \text{ V}, I_D = 0.75 \text{ A}$		0.280	0.350	$\Omega$
		$V_{GS} = 2.5 \text{ V}, I_D = 0.50 \text{ A}$		0.355	0.450	
Forward Transconductance <sup>a</sup>	$g_f$	$V_{DS} = 15 \text{ V}, I_D = 0.75 \text{ A}$		1.5		S
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = 0.24 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V
<b>Dynamic<sup>b</sup></b>						
Total Gate Charge	$Q_g$	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 0.75 \text{ A}$		1.3	2.0	nC
Gate-Source Charge	$Q_{gs}$			0.31		
Gate-Drain Charge	$Q_{gd}$			0.5		
Turn-On Delay Time	$t_{d(\text{on})}$	$I_D \approx 0.75 \text{ A}, V_{DD} = 15 \text{ V}, R_L = 20 \Omega$ $V_{GEN} = 4.5 \text{ V}, R_g = 6 \Omega$		11	20	ns
Rise Time	$t_r$			18	30	
Turn-Off Delay Time	$t_{d(\text{off})}$			17	30	
Fall Time	$t_f$			11	20	
Source-Drain Reverse Recovery Time	$t_{rr}$	$I_F = 0.24 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$		30	60	

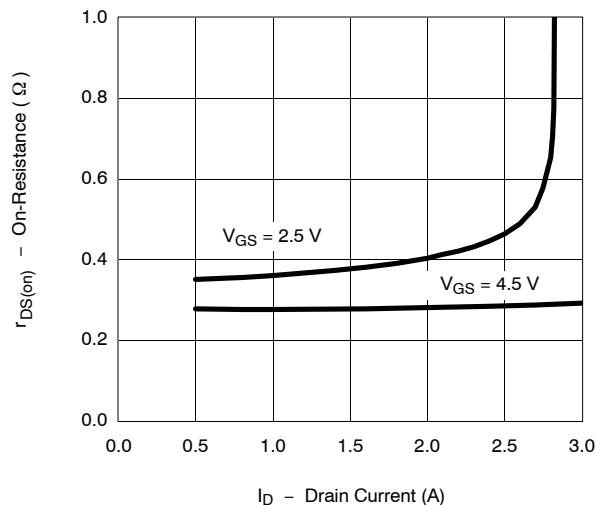
Notes

- a. Pulse test; pulse width  $\leq 300 \mu\text{s}$ , duty cycle  $\leq 2\%$ .
- b. Guaranteed by design, not subject to production testing.

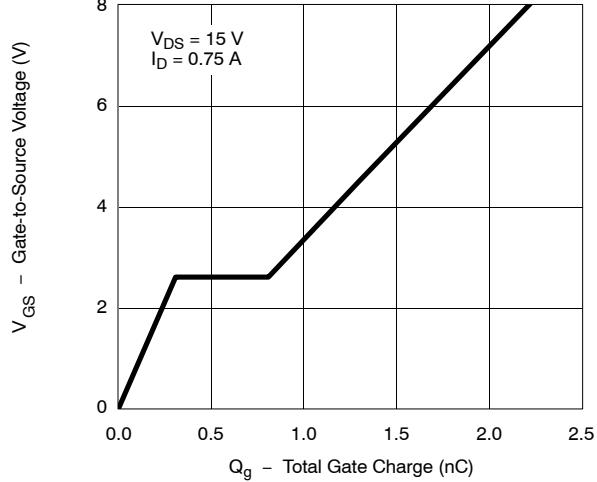
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**

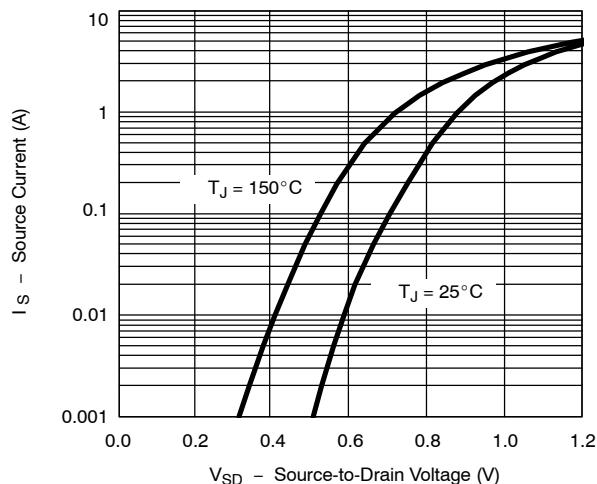


**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**
**On-Resistance vs. Drain Current**


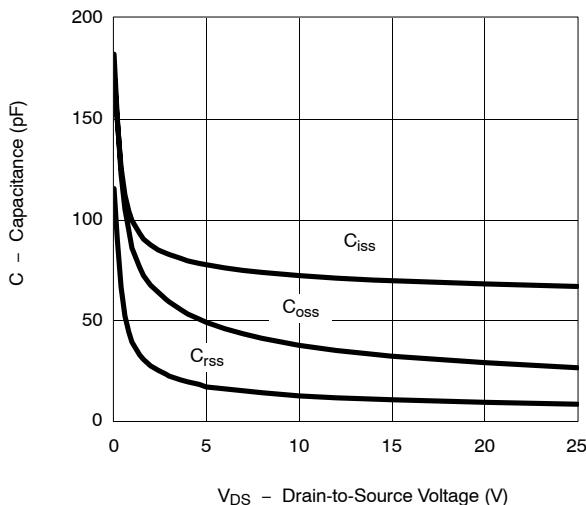
ID – Drain Current (A)

**Gate Charge**


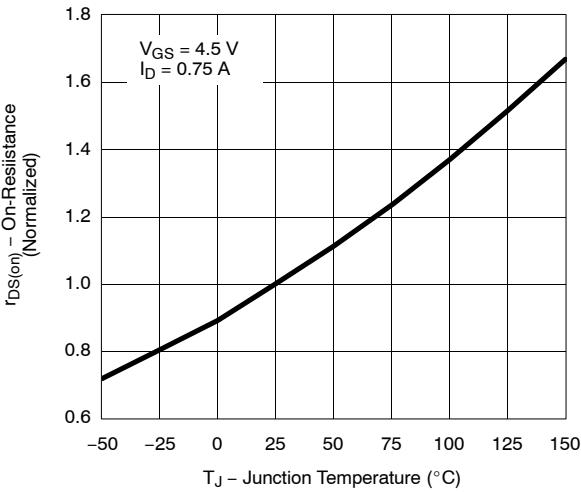
Qg – Total Gate Charge (nC)

**Source-Drain Diode Forward Voltage**


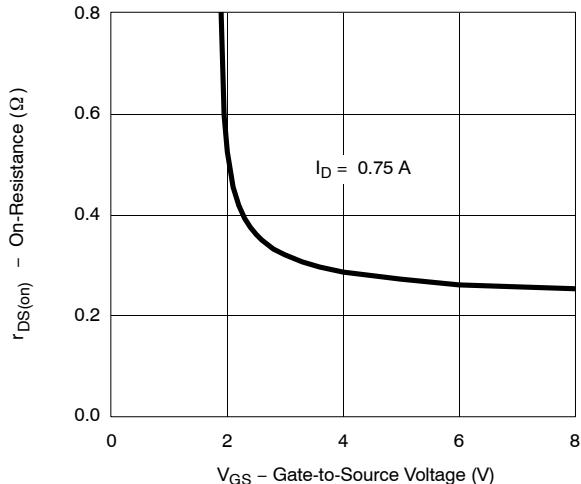
VSD – Source-to-Drain Voltage (V)

**Capacitance**


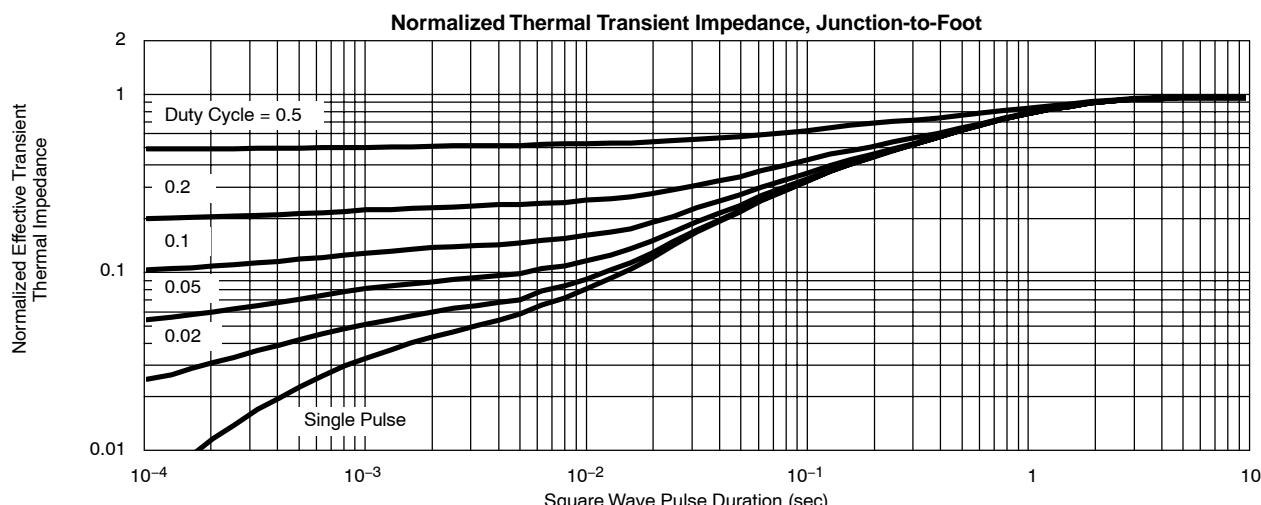
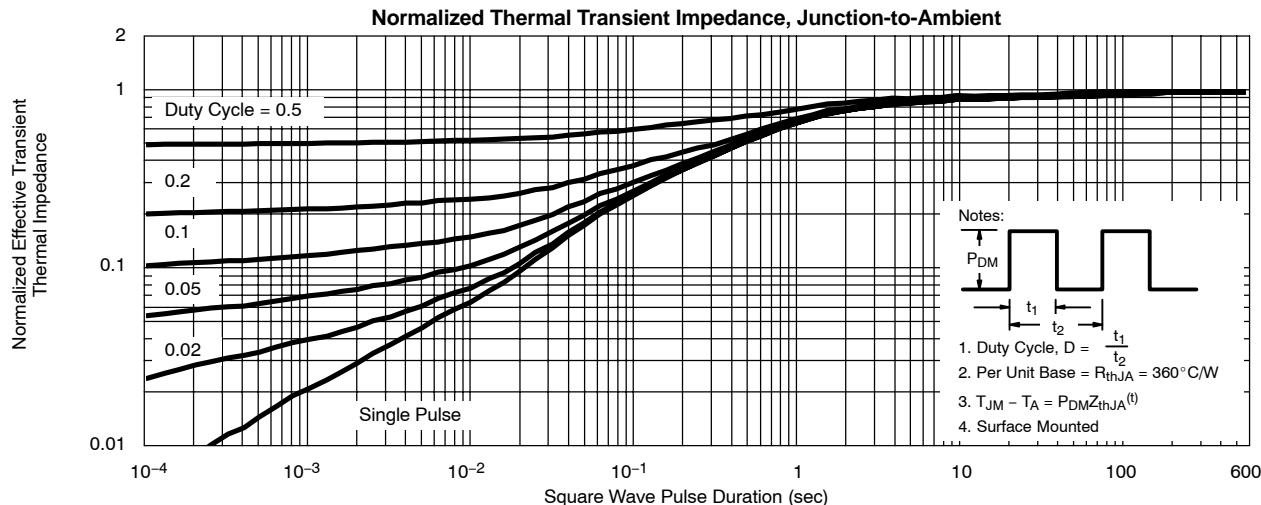
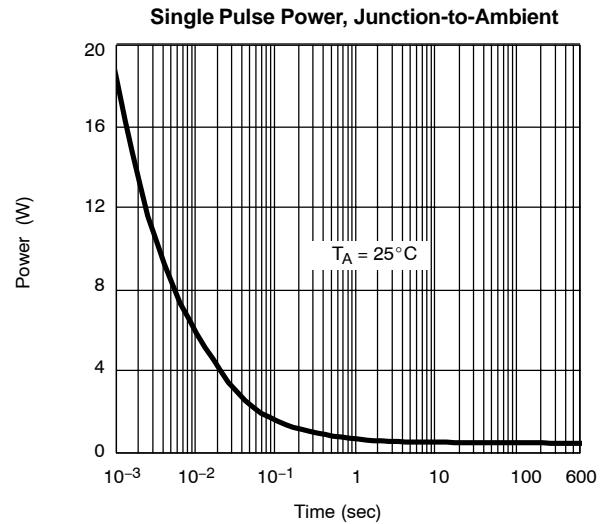
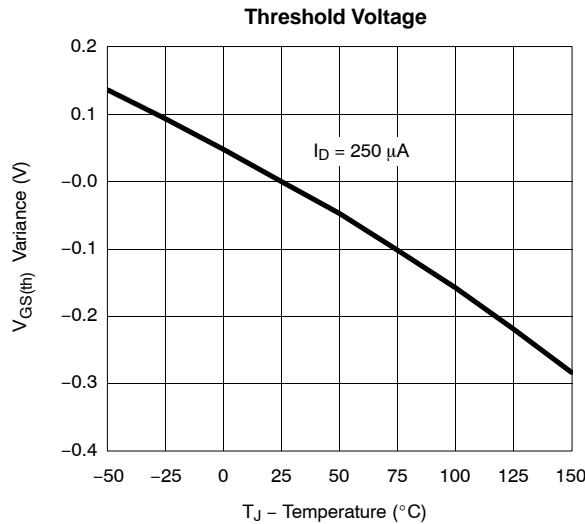
VDS – Drain-to-Source Voltage (V)

**On-Resistance vs. Junction Temperature**


Tj – Junction Temperature (°C)

**On-Resistance vs. Gate-to-Source Voltage**


VGS – Gate-to-Source Voltage (V)

**Si1304DL****Vishay Siliconix**
**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**


Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <http://www.vishay.com/ppg?71315>.